Preferred Device

## SWITCHMODE Power Rectifier

These state-of-the-art devices use the Schottky Barrier principle with a proprietary barrier metal.

### Features

- Guardring for Stress Protection
- Maximum Die Size
- 175°C Operating Junction Temperature
- Short Heat Sink Tab Manufactured Not Sheared
- AEC-Q101 Qualified and PPAP Capable
- NRVBB Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements
- All Packages are Pb-Free\*

### Mechanical Characteristics:

- Case: Epoxy, Molded, Epoxy Meets UL 94 V-0
- Weight: 1.7 Grams (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads Readily Solderable
- Device Meets MSL1 Requirements
- ESD Ratings:
  - ◆ Machine Model = C (> 400 V)
  - ◆ Human Body Model = 3B (> 8000 V)



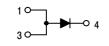
## **ON Semiconductor®**

http://onsemi.com

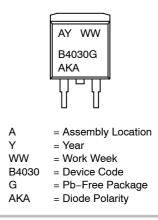
## SCHOTTKY BARRIER RECTIFIER 40 AMPERES, 30 VOLTS



D<sup>2</sup>PAK CASE 418B STYLE 3



## MARKING DIAGRAM



#### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

Preferred devices are recommended choices for future use and best overall value.

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	30	V	
Average Rectified Forward Current (At Rated $V_R$ ) $T_C$ = +115°C (Note 1)	I <sub>F(AV)</sub>	40	A	
Peak Repetitive Forward Current (At Rated V <sub>R</sub> , Square Wave, 20 kHz), T <sub>C</sub> = +112°C	I <sub>FRM</sub>	80	А	
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	300	А	
Peak Repetitive Reverse Surge Current (2.0 µs, 1.0 kHz)	I <sub>RRM</sub>	2.0	А	
Storage Temperature Range	T <sub>stg</sub>	-65 to +175	°C	
Operating Junction Temperature Range (Note 2)	TJ	-65 to +175	°C	
Voltage Rate of Change (Rated V <sub>R</sub> )	dv/dt	10,000	V/μs	
Reverse Energy (Unclamped Inductive Surge), (T <sub>C</sub> = 25°C, L = 3.0 mH)	W	600	mJ	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Rating applies when pins 1 and 3 are connected.

2. The heat generated must be less than the thermal conductivity from Junction-to-Ambient:  $dP_D/dT_J < 1/R_{\theta JA}$ .

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case	$R_{ ext{ heta}JC}$	1.0	°C/W
Thermal Resistance, Junction-to-Ambient (Note 3)	$R_{ hetaJA}$	50	°C/W

3. Rating applies when surface mounted on the miniumum pad size recommended.

#### **ELECTRICAL CHARACTERISTICS**

Characteristic	Symbol	Value	Unit
	V <sub>F</sub>	0.46 0.34 0.55 0.45	V
Maximum Instantaneous Reverse Current (Note 5), per Device (Rated DC Voltage, $T_C = +25^{\circ}C$ ) (Rated DC Voltage, $T_C = +125^{\circ}C$ )	IR	0.35 150	mA

4. Rating applies when pins 1 and 3 are connected.

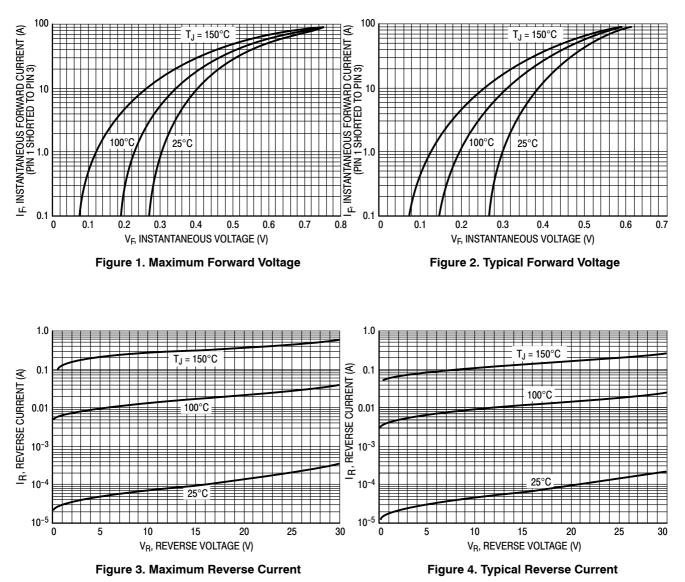
5. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MBRB4030G	D <sup>2</sup> PAK (Pb–Free)	50 Units / Rail
MBRB4030T4G	D <sup>2</sup> PAK (Pb-Free)	800 Units / Tape & Reel
NRVBB4030T4G	D <sup>2</sup> PAK (Pb–Free)	800 Units / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

#### **ELECTRICAL CHARACTERISTICS**



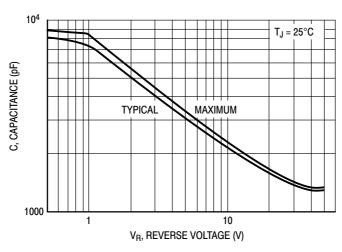


Figure 5. Maximum and Typical Capacitance

#### **ELECTRICAL CHARACTERISTICS**

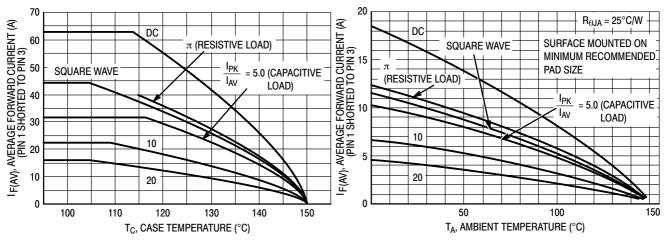
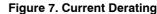
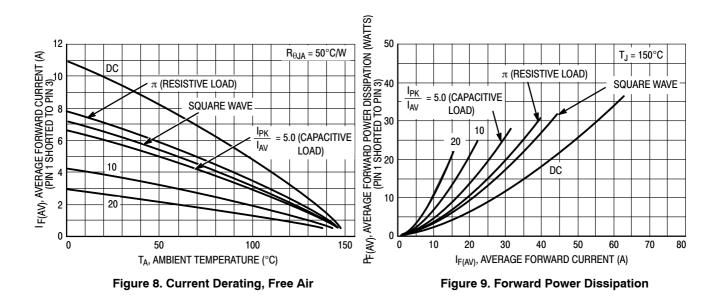


Figure 6. Current Derating, Infinite Heatsink





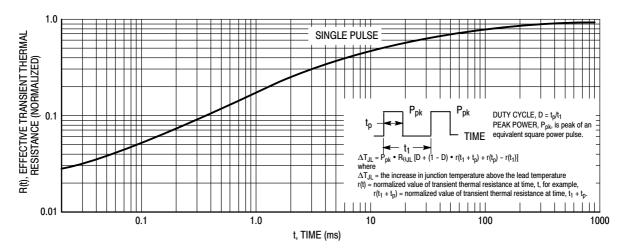
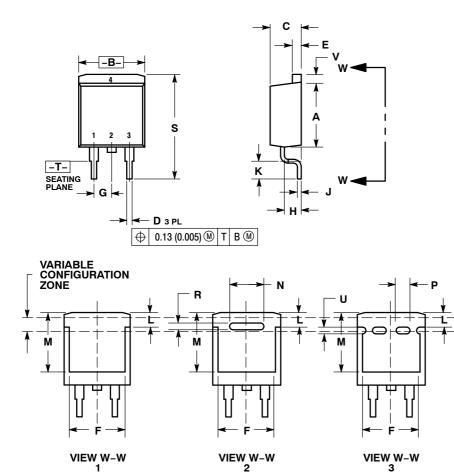


Figure 10. Thermal Response

#### PACKAGE DIMENSIONS





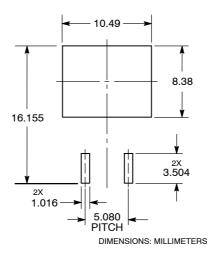
NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH. 3. 418B-01 THRU 418B-03 OBSOLETE, NEW STANDARD 418B-04.

	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.340	0.380	8.64	9.65
В	0.380	0.405	9.65	10.29
С	0.160	0.190	4.06	4.83
D	0.020	0.035	0.51	0.89
Е	0.045	0.055	1.14	1.40
F	0.310	0.350	7.87	8.89
G	0.100 BSC		2.54 BSC	
Н	0.080	0.110	2.03	2.79
J	0.018	0.025	0.46	0.64
Κ	0.090	0.110	2.29	2.79
L	0.052	0.072	1.32	1.83
М	0.280	0.320	7.11	8.13
Ν	0.197	REF 5.00 REF		
Ρ	0.079 REF		2.00 REF	
R	0.039	REF	0.99 REF	
S	0.575	0.625	14.60	15.88
v	0.045	0.055	1.14	1.40

STYLE 3: PIN 1. ANODE 2. CATHODE 3. ANODE 4. CATHODE

VIEW W-W

#### **SOLDERING FOOTPRINT\***



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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**MBRB4030/D** 

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